

Full Flip-Chip COB Process

Adopting full flip-chip COB process panels with a surface hardness of up to 4H, providing multi-protection against moisture, dust, and impact.

Immersive Experience, True Colour Perception

Carefully selected PWM odriver ICs for more natural grayscale transitions, delivering an ultra-wide colour gamut and realistic visuals.



High Contrast



Energy-Efficient

Matte Finish, Uniform Deep Black



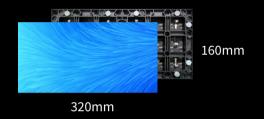


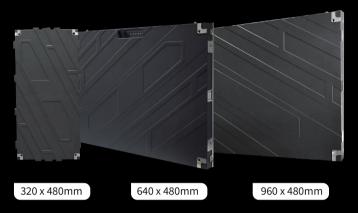
Magnetic Mounting Design, Ultimate Flatness

The rear features a magnetic mounting design, allowing independent adjustment of magnet height to ensure precise and even flatness across the display surface.

Broad Compatibility with Various Cabinet Sizes

The module adopts a standardized 320 x 160mm size, compatible with different die-cast cabinet sizes such as 320×480 mm, 640×480 mm, and 960×480 mm.





*The actual appearance may vary depending on reality. (Optional cabinets are available.)

SPECIFICATIONS

Module Size (W×H×D)/(mm)	320 x 160	
Model	UMC3216-15VA	UMC3216-18VA
Pixel Pitch (mm)	P1.5385	P1.86
Panel Technology	СОВ	СОВ
Module Resolution	208 x 104	172 x 86
Gray Scale(Bits)	13	13
Brightness(cd/m²)	600	600
Viewing Angle(H./V.)	170°/170°	170°/170°
Colour Temperature(K)	3000 ~ 9300(adjustable)	3000 ~ 9300(adjustable)
Refresh Rate (Hz)	3840	3840
Power Consumption Max (W/m²)	450	450
Power Consumption Typical (W/m²)	150	150
Working Voltage	AC: 100V~240V, 50/60Hz	AC: 100V~240V, 50/60Hz
Lifetime(Hours)	100,000	100,000
Operating Temp(°C)	-10 ~ +50	-10 ~ +50
Humidity Range(%RH)	10 ~ 80	10 ~ 80